COMPLIANT

HALOGEN

FREE

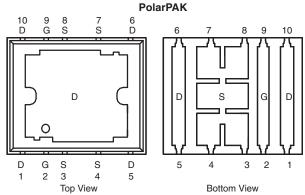


Vishay Siliconix

N-Channel 30-V (D-S) MOSFET with Schottky Diode

PRODUCT SUMMARY						
		I _D (A) ^a				
V _{DS} (V)	R _{DS(on)} (Ω) ^e	Silicon Limit	Package Limit	Q _g (Typ.)		
30	0.0024 at $V_{GS} = 10 \text{ V}$	175	60	50 nC		
30	0.0033 at $V_{GS} = 4.5 \text{ V}$	149	60	50 HC		

Package Drawing www.vishay.com/doc?72945



Top surface is connected to pins 1, 5, 6, and 10

Ordering Information: SiE726DF-T1-E3 (Lead (Pb)-free)

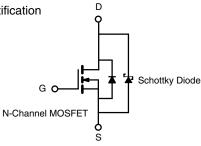
SiE726DF-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- SkyFET™ Monolithic TrenchFET[®] Power MOSFET and Schottky Diode
- Ultra Low Thermal Resistance Using Top-Exposed PolarPAK[®] Package for Double-Sided Cooling
- Leadframe-Based New Encapsulated Package
 - Die Not Exposed
 - Same Layout Regardless of Die Size
- Low Q_{ad}/Q_{as} Ratio Helps Prevent Shoot-Through
- 100 % R_q and UIS Tested
- Compliant to RoHS directive 2002/95/EC

APPLICATIONS

- · Synchronous Rectification
- DC/DC
- Low-Side Switch



For Related Documents www.vishay.com/ppg?68626

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 20		
	T _C = 25 °C		175 (Silicon Limit)		
	16-20-0		60 ^a (Package Limit)		
Continuous Drain Current ($T_J = 150 ^{\circ}C$)	T _C = 70 °C	I _D	60 ^a		
	T _A = 25 °C		35 ^{b, c}		
	T _A = 70 °C		28 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	80		
Continuous Source-Drain Diode Current	T _C = 25 °C		60 ^a		
Continuous Source-Diam Diode Current	T _A = 25 °C	I _S	4.3 ^{b, c}		
Single Pulse Avalanche Current L = 0.1 mH		I _{AS}	50		
Avalanche Energy		E _{AS}	125	mJ	
	T _C = 25 °C		125		
Maximum Power Dissipation	T _C = 70 °C	P _D	80	w	
Maximum Fower Dissipation	T _A = 25 °C	' D	5.2 ^{b, c}	VV	
	T _A = 70 °C		3.3 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) ^{d, e}		ı ,	260		

Notes:

- a. Package limited.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. See Solder Profile (www.vishay.com/ppg?73257). The PolarPAK is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

SiE726DF

Vishay Siliconix



THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
		R_{thJA}	20	24		
Maximum Junction-to-Case (Drain Top)	Steady State	R _{thJC} (Drain)	0.8	1	°C/W	
Maximum Junction-to-Case (Source)a, c		R _{thJC} (Source)	2.2	2.7		

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. Maximum under Steady State conditions is 68 °C/W.c. Measured at source pin (on the side of the package).

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_{D} = 1 \text{ mA}$	30			V	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu\text{A}$	1		3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V		0.120	0.5	mA	
		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C		1.0	10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	25			Α	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 25 A		0.0020	0.0024	Ω	
		$V_{GS} = 4.5 \text{ V}, I_D = 25 \text{ A}$		0.0026	0.0033		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 25 A		90		S	
Dynamic ^b							
Input Capacitance	C _{iss}			7400		pF	
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		1100			
Reverse Transfer Capacitance	C _{rss}			400			
Total Gate Charge	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		105	160	nC	
		$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		50	75		
Gate-Source Charge	Q_{gs}			22			
Gate-Drain Charge	Q_{gd}			12			
Gate Resistance	R_g	f = 1 MHz		1	2	Ω	
Turn-On Delay Time	t _{d(on)}			60	90	-	
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω		35	55		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		55	85		
Fall Time	t _f	-		30	45		
Turn-On Delay Time	t _{d(on)}			20	30	ns	
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω		10	15	- - -	
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ 10 A, V_{GEN} = 10 V, R_g = 1 Ω		55	85		
Fall Time	t _f	-		10	15		
Drain-Source Body Diode and Schottky	Characteristi	cs		•			
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			60	60	
Pulse Diode Forward Current ^a	I _{SM}				80	Α	
Body Diode Voltage	V_{SD}	I _S = 2 A		0.37	0.45	V	
Body Diode Reverse Recovery Time	t _{rr}	-		40	60	ns	
Body Diode Reverse Recovery Charge Q _{rr}		1 10 A dl/d+ 100 A/vo T 05 °C		30	45	nC	
Reverse Recovery Fall Time	t _a			19		ns	
Reverse Recovery Rise Time				21			

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing.

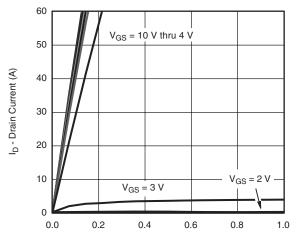
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





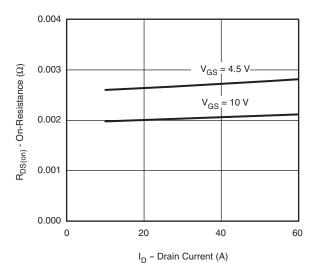
Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

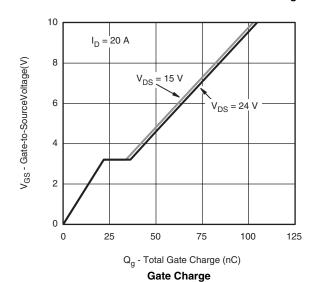


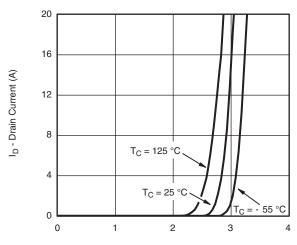
V_{DS} - Drain-to-Source Voltage (V)

Output Characteristics



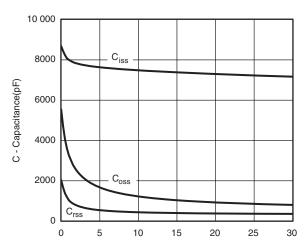
On-Resistance vs. Drain Current and Gate Voltage





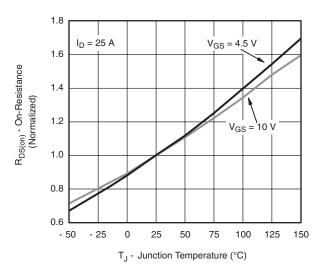
V_{GS} - Gate-to-Source Voltage (V)

Transfer Characteristics



 V_{DS} - Drain-to-Source Voltage (V)

Capacitance



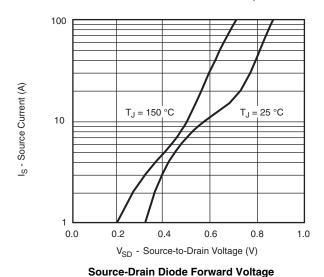
On-Resistance vs. Junction Temperature

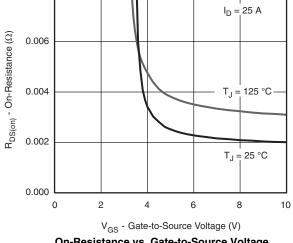
0.008

SiE726DF

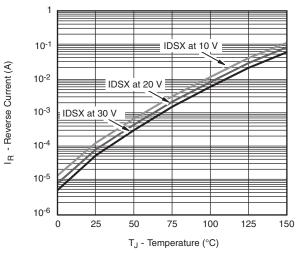
Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

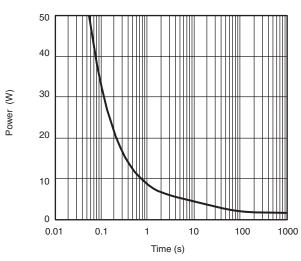




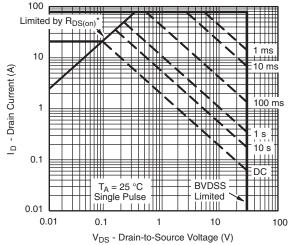
On-Resistance vs. Gate-to-Source Voltage



Reverse Current vs. Junction Temperature



Single Pulse Power, Junction-to-Ambient



* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

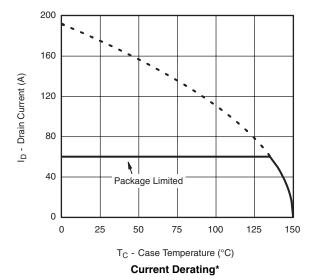
Safe Operating Area, Junction-to-Ambient

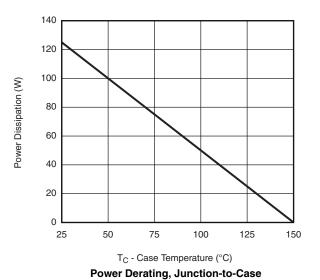


SiE726DF

Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





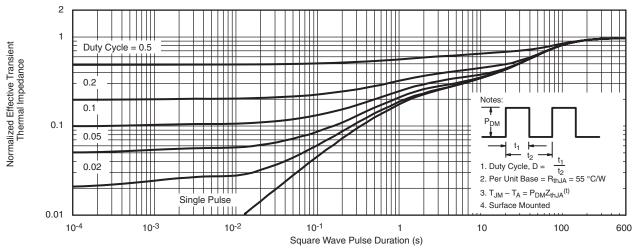
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

SiE726DF

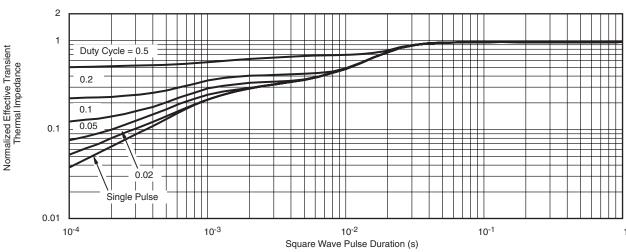
Vishay Siliconix



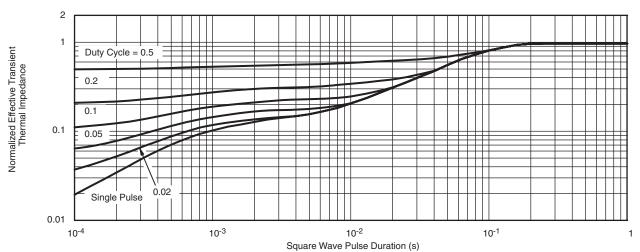
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case (Drain Top)



Normalized Thermal Transient Impedance, Junction-to-Source

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg268626.



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for vishay manufacturer:

Other Similar products are found below:

M39006/22-0577H Y00892K49000BR13L VSKT250-16PBF M8340109M6801GGD03 NTCALUG01A103F291L ITU1341SM3 VS-MBRB1545CTPBF 1KAB100E 1KAB20E CP0005150R0JE1490 S472M69Z5UR84K0R MKP1848C65090JY5L 562R5GAD47RR CRCW1210360RFKEA VSMF4720-GS08 TSOP34438SS1V CRCW04024021FRT7 001789X LTO050FR0500JTE3 CRCW08054K00FKTA LVR10R0200FE03 009923A CRCW2010331JR02 CS6600552K000B8768 CSC07A0110K0GPA M34C156K100BZSS M39003/01-2289 M39003/01-2784 M39006/25-0133 M39006/25-0228 M64W101KB40 M64Z501KB40 CW001R5000JS73 CW0055R000JE12 CW0056K800JB12 CW0106K000JE73 672D826H075EK5C CWR06JC105KC CWR06NC475JC MAL219699001E3 MCRL007035R00JHB00 92MT80KPBF PTF56100K00QYEK PTN0805H1502BBTR1K RCWL1210R130JNEA RH00515R80FC02 RH005220R0FE02 RH005330R0FC02 RH010R0500FC02 132B20103